PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT8049707

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
BRADLEY D.A. BOND	07/07/2023

RECEIVING PARTY DATA

Name:	BOND FORMWORK SYSTEMS, LLC
Street Address:	18735 MATHIS ROAD
City:	WALLER
State/Country:	TEXAS
Postal Code:	77487

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	18219553

CORRESPONDENCE DATA

Fax Number:	(832)201-8247

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone:	8662012030
Email:	docketing@nls.law
Correspondent Name:	NOLTE LACKENBACH SIEGEL
Address Line 1:	500 STONEGATE DR.
Address Line 4:	KATY, TEXAS 77494

ATTORNEY DOCKET NUMBER:	BOND-009UTIL_T1
NAME OF SUBMITTER:	N. ALEXANDER NOLTE
SIGNATURE:	/N. Alexander Nolte/
DATE SIGNED:	07/11/2023

Total Attachments: 2
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COMBINED DECLARATION AND ASSIGNMENT
FOR UTILITY AND DESIGN PATENT APPLICATION

Title of Application

UNIVERSAL PROP SYSTEM FOR GRID SHORING

Filing Date: _____   **Application No.:** _____

DECLARATION

As a below named inventor, I hereby declare that:

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNMENT

In this Assignment, the "Patent Items" include the above-identified application for Patent and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (C-I-P's), divisionals, and renewals of and substitutes for said application for said Patent, and any and all other Patent(s) of any countries thereto which may be granted thereon or therefore, and any reissues, or reexaminations, or extensions of said Patent(s).

I/We, the undersigned (each):

hereby confirm the assignment and transfer of the entire right, title and interest, including the right of priority, in, to and under the Patent Items to BOND FORMWORK SYTEMS, LLC by virtue of a previously executed agreement, acknowledge that I/we have previously agreed to assign and transfer to BOND FORMWORK SYSTEMS, LLC the entire right, title and interest, including the right of priority, in, to and under the Patent Items, and to the extent not already effected by a previously executed agreement, for good and valuable consideration, the receipt of which is hereby acknowledged, and in furtherance of my/our obligations to BOND FORMWORK SYSTEMS, LLC, a Limited Liability Company, 18735 Mathis Road, Waller, Texas 77487, (hereinafter BOND), and to its subsidiaries and affiliates, hereby assign and transfer to BOND, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under the Patent Items.

I/we additionally authorize BOND to file applications in my/our name for Patent in any country, to be held and enjoyed by BOND, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment and transfer not been made;

AND I/we hereby covenant that I/we have full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said Patent Items, to BOND, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to BOND, or to its nominee, all known facts respecting said invention(s) or improvement(s), said Patent Items, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, C-i-P's, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid BOND, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) in any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by BOND;

AND I/we hereby authorize and request the official of any country or countries whose duty it is to issue patents on applications as aforesaid, to issue to BOND, as assignee of the entire right, title and interest, any and all Patent(s) for said invention(s) or improvement(s) which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment.

I/we further authorize and direct the attorneys of record to insert the filing date and application number of said application for Patent, now identified by the Matter No. and title set forth above, as soon as the same shall have been made known to them.

IN WITNESS WHEREOF, I/we hereunto set my/our hand(s) and seal(s):

Inventor's Signature - 1	7/7/023
	Date
Bradley D.A. Bond	
First/Middle Name/Last Name	
Inventor's Signature - 2	Date
First/Middle Name/Last Name	
Inventor's Signature - 3	Date
First/Middle Name/Last Name	
Inventor's Signature - 4	Date
First/Middle Name/Last Name	
Inventor's Signature - 5	Date
First/Middle Name/Last Name	
Inventor's Signature - 6	Date
First/Middle Name/Last Name	
Inventor's Signature - 7	Date
First/Middle Name/Last Name	